

Key Features

- ❑ QUAD N-CHANNEL MOSFET DRIVE FOR SINGLE H-BRIDGE DC-MOTOR CONTROL
- ❑ CHARGE PUMP TO CONTROL HIGH SIDE DRIVERS
- ❑ INTEGRATED 5 V POWER SUPPLY FOR EXTERNAL COMPONENTS (μ CONTROLLER, etc.)
- ❑ BATTERY VOLTAGE MONITOR
- ❑ SINGLE WIRE BUS INTERFACE
- ❑ STANDBY AND WAKEUP CAPABILITY
- ❑ VARIOUS PROTECTION CIRCUITRIES:
- ❑ WATCHDOG, LOW SIDE VOLTAGE LIMITTER

General Description

Advanced automotive distributed DC-motor H-Bridge Controller subsystem for Door and Seat modules with integrated Bus Interface and Battery Management System

Applications

- Door modules
- Seat modules

Functional Description

The AS8420 integrates an advanced DC - Motor H - Bridge driver control, a Voltage regulator and a single wire Bus Interface to realize a very compact remote motor control system.

The H - Bridge control integrates the necessary functions for propper motor driving and protection as: High Side driver and Low Side driver for external Power MOSFETs, a Charge Pump for propper High Side driving, a Low Side switch Supply Limiter and a Current Amplifier for current monitoring and overcurrent protection.

The Charge Pump voltage (VCP) is generatetd to typical +10V higher than the battery voltage VBB.

Builtin security functions disable the AS8420 when abnormal conditions like overvoltage, undervoltage, overtemperature or loss of control (watchdog) occur.

Controlled current slew rate of the external Gate and cross-switch delay during PWM recirculation operation are provided. The ramp of the gate current and the dead time

for secure synchronous rectification are controlled by an internal current reference.

A current measurement subcircuit (voltage drop at an external shunt resistor) provides the analog voltage signal SENSE and sets or resets an over current flag OC. IF OC is set, all High side and Low side drivers are switched off. An voltage drop of more than typ. 500 mV performs a set OC.

The analog output signal CURR is the SENSE input, amplified by a voltage gain of 10.

The Voltage regulator integrates a Regulated Power Supply from battery, Reset control, Supply Monitor, Watchdog an Standby management.

A trimmed bandgap is used as reference for a Low Drop Voltage Regulator with a nominal output voltage of 5 V. This regulator is capable to deliver a supply current of up to 20 mA. In cases a higher supply current is needed, an external bipolar transistor can be connected as shown in **Figure 4 full configured μ Controller driven system** please refer to application section.

Battery supply Over- and -Undervoltage checks are performed independently. An appropriate hysteresis guarantees the correct switching behaviour. If battery voltage goes out of operating range the fault signal FB is activated.

The VDD Monitor controls the regulated power supply voltage. The Watchdog is driven from an onchip low current RC - oscillator. In case of lossed control it generates a fail signal. This signal and the VDD Monitor output are combined to the Reset output signal RES.

A standby circuitry can be used to bring the AS8420 in a power save mode. Bus activity (LIN) will awake the circuit. The Bus Interface circuitry fulfils the LIN standard. A TTP/A Interface will be available soon.

To guarantee a high flexibility and cost effective solution the protocol handler intenionally is not integrated on the chip.

To simplify a system solution we also offer a double chip solution in one package.

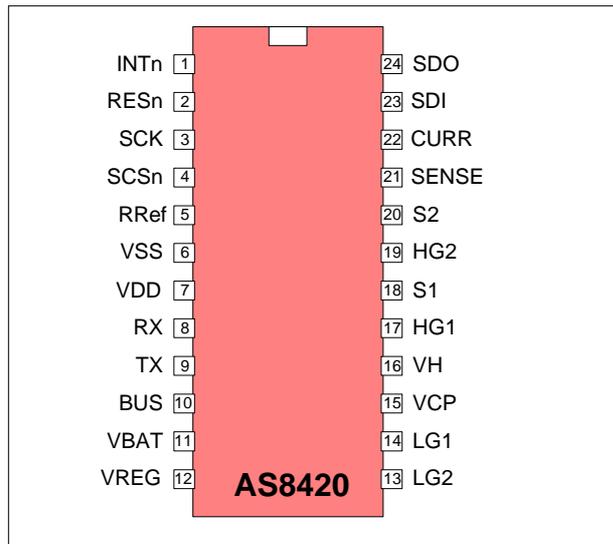


Figure 1 Pinout of AS8420

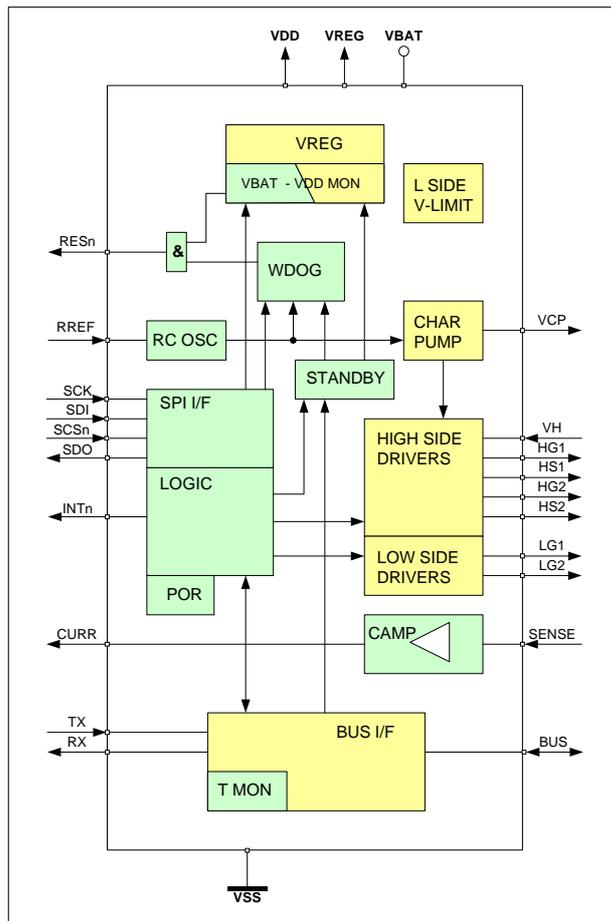


Figure 2 Block Diagram of AS8420

Package Information

SOIC24

Pin Description, Pin Types

AIO analog I/O
 DI digital input
 DIO_T digital I/O / tristate
 DI_PD digital input with pull-down
 DO_T digital output / tristate
 DO digital output
 DO_OD digital output open drain
 S supply pad

Pin	Name	Type	Note
1	INTn	DO_T	Low active Interrupt signal
2	RESn	DO_OD	Reset - open drain
3	SCK	DI_PD	Serial Clock from μ C
4	SCSn	DI_PU	Low active Chip Select signal (1)
5	RREF	AIO	Reference Resistor for RC Oscillator
6	VSS	S	Power Ground
7	VDD	S	5 V power supply
8	RX	DO	Bus transmission output
9	TX	DI_PU	Bus transmission input (1)
10	BUS	AIO	Bus line
11	VBAT	S	Battery Voltage (diode protected)
12	VREG	AIO	regulated supply - if ext. transistor is not used, shorted to VDD
13	LG2	AIO	Output Gate LS driver 2
14	LG1	AIO	Output Gate LS driver 1
15	VCP	AIO	Output Charge Pump
16	VH	AIO	Charge Pump voltage (capacitor)
17	HG1	AIO	Output Gate HS driver 1
18	S1	AIO	Output Source HS driver 1
19	HG2	AIO	Output Gate HS driver 2
20	S2	AIO	Output Source HS driver 2
21	SENSE	AIO	Analog input current measurement
22	CURR	AIO	current measurement output
23	SDI	DI	Serial Data In
24	SDO	DO_T	Serial Data Out

Table 1 Pinlist of AS8420

- Note 1: In case external VDD is below V_{fVDD} threshold SPI I/F and LIN Failure detection unit are inactive
- Note 2: During sleep mode this pin is clamped to VSS by switching on a pull down resistor, that is normally OFF
- Note 3: During sleep mode RX output is switched Low to prevent circuitry from reverse supply of μ Controller

Electrical Parameters

Absolute Maximum Ratings (NON OPERATING)

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated under "Operating Conditions" is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Parameter	Symbol	Min	Max	Unit	Note
Battery voltage	VBAT	-0.3	20	V	(1) 42V for 400ms
Low Power Supply Voltage	VDD	-0.3	7	V	(1)
Input Pin Voltage	Vin	-0.3	VDD/V+0.3	V	
Input Current (latchup immunity)	Iscr	-100	100	mA	Norm: Jedec 17
ESD		±1		kV	Norm: MIL 883 E method 3015
Total Power dissipation	Pt		300	mW	
Storage temperature	Tstrg	-55	125	°C	
Soldering conditions	Tlead		235	°C	Norm: IEC 61760-1
Humidity non-condensing		5	85	%	

Table 2 Absolute Maximum Ratings

Note 1: Value of these process dependent parameters to be taken from according Process Parameter document, current version

Operating Conditions

Parameter	Symbol	Min	Max	Unit	Note
Battery voltage	VBAT	7	18	V	(1)
Low Power Supply Voltage	VDD	4.75	5.25	V	(2)
Voltage drop on ground potential	VSS-GND	-0.1	0.1	V	
Ambient temperature	Tamb	-40	85	°C	

Table 3 Operating Conditions

Note 1: Load dump 42V

Note 2: Recommended external capacitors $\geq 100\text{nF}$
20 mA max. load, higher current with external transistor

Characteristics for Analog and Digital Inputs and Outputs

Operational Parameters

Parameter	Symbol	Min	Max	Unit	Note
Charge Pump Voltage	VCP	VBAT/V+5	VBAT/V+12	V	(1) typ. VBB/V + 10 V
HS gate driver source current	IHS_so	-100	25	mA	(2) + (3)
HS gate driver sink current	IHS_si	25	100	mA	(2) + (3)
LS gate driver source current	ILS_so	-100	25	mA	(2) + (3)
LS gate driver sink current	ILS_si	25	100	mA	(2) + (3)
Oscillator frequency	fOSC	480	800	kHz	OnChip
PWM frequency	fPWM1	15	25	kHz	(4) typ 20 kHz
	fPWM2	8	12		(5) typ 10 kHz
PWM resolution	resPWM			bit	typ. 5
PWM duty cycle	Dr	10	100	%	(6)
Dead Time for secure synchronous rectification	tdelay	2	5	µs	(7) typ. 3
Motor current measurement error	Evcrr	-10	10	%	
Threshold for motor over current detection	Voc			mV	(8) typ. 500mV
Under Voltage VBAT	Vfuv	7	7.9	V	(9) + (10)
Over Voltage VBAT	Vfov	18	20	V	(9) + (10)
Under Voltage VDD	Vfuvdd	0,8*VDD	0,9*VDD	V	(9) + (10)
Over Voltage VDD	Vfovdd	1,1*VDD	1,2*VDD	V	(9) + (10)
Watchdog signal pulse width	twdres	10	40	us	(11) active low
Watchdog time out period	twdtrig	1.0	2.3	s	(12) typ. 1.5 sec
switch off delay	tsw_off	1	2	ms	(7)
dead time after VBAT Fault	td_FBAT	2		ms	(7)
Temperature threshold warning	TW			°C	(13) typ. 140
Temperature threshold Vreg	TOff	160		°C	(13)
Standby Current	IDD		100	µA	(14)
Gain of Current Amplifier	gCAmp1				(15) typ. 10
	gCAmp2				(15) typ. 15
Value of external Reference resistor	Rref			kΩ	±1 % typ 22
reset active time after Power On or WakeUp	tRES1	200		ms	(7)
reset active time before Power Off	tRES2	1		ms	(7)
Debounce Time of internal signals	tdeb2			µs	(7) typ. 30
MOSFET driver current control	Irramp	25	100	µs	Internal current ref.

Table 4 analog signal parameters

Note 1: External capacitors C > 200 nF recommended, Lower threshold > 8 V according to VBB Monitor.

Note 2: Typical rise/ fall time at the Power MOSFET gate: 1 µs.

Note 3: Recommended Power MOSFET STB80NE06L-10, Gate approx. 7,6nF/ model, RDSon = 0,01 Ω.

Note 4: depending on value of reference resistor.

Note 5: Depending on settings of Global Control Register, bit PWMF.

Note 6: Programmable via SPI I/F.

Note 7: internal time base.

Note 8: Rsens value depends on motor current.

Note 9: Interrupt becomes active.

Note 10: 250 mV hysteresis.

Note 11: Active low digital output triggered by Watch Dog overflow.

Note 12: Digital input from microprocessor within a time between 200 and 1000 ms.

Note 13: Hysteresis > 10 μ V.

Note 14: Voltage regulator, internal oscillator NOT running, 25 °C, VBAT = 14 V.

Note 15: Depending on setting of Global Control Register, bit GAIN.

CMOS Input

Parameter	Symbol	Min	Max	Unit	Note
High Level Input Voltage	VIH	0.7 * VDD		V	
Low Level Input Voltage	VIL		0.3 * VDD	V	
Input Leakage Current	ILEAK		1	μ A	

Table 5 CMOS Input parameters

CMOS output

Parameter	Symbol	Min	Max	Unit	Note
High Level Output Voltage	VOH	VDD/V-0.5		V	
Low Level Output Voltage	VOL		VSS/V+0.4	V	
Capacitive Load	CL		50	pF	

Table 6 CMOS output parameters

Tristate CMOS output

Parameter	Symbol	Min	Max	Unit	Note
High Level Output Voltage	VOH	VDD/V-0.5		V	
Low Level Output Voltage	VOL		VSS/V+0.4	V	
Tristate Leakage Current	IOZ		1	μ A	to VDD and VSS

Table 7 Tristate CMOS output parameters

CMOS open-drain output

Parameter	Symbol	Min	Max	Unit	Note
Low Level Output Voltage	VOL		0.4	V	IOL = 4mA
Open drain leakage current	ILEAK	-10	10	μ A	
Capacitive Load	CL		50	pF	

Table 8 CMOS open-drain parameters

MicroController Interface

Registerfile

ADDRESS - hexadecimal	Name	ACCESS	Description
00	GCR1	R/W	Global Control Register 1
01	GCR2	R/W	Global Control Register 2
02	PSR	R/W	PWM SetUp Register
03	FDR	R/W	FailureDetection Register
04	TST	R/W	Test Mode Register
05	MSK	R/W	Interrupt Mask Register
07	MRR	R	Mask Release Register

Table 9 Registerfile description

SPI Interface

Data transfer from the microprocessor to the ASIC and vica versa is accomplished by means of a SPI interface. For a detailed description of the SPI-interface features please refer to [SPI].

Physical Interface

Supported modes, and bit order are shown in Figure 3. Only modes that conform to CPHA=1 (see [SPI]) are supported. With this mode the output shift operation always takes place before the input sample operation. The clock polarity is fix CPOL = 0. The MSB is always transmitted / received first.

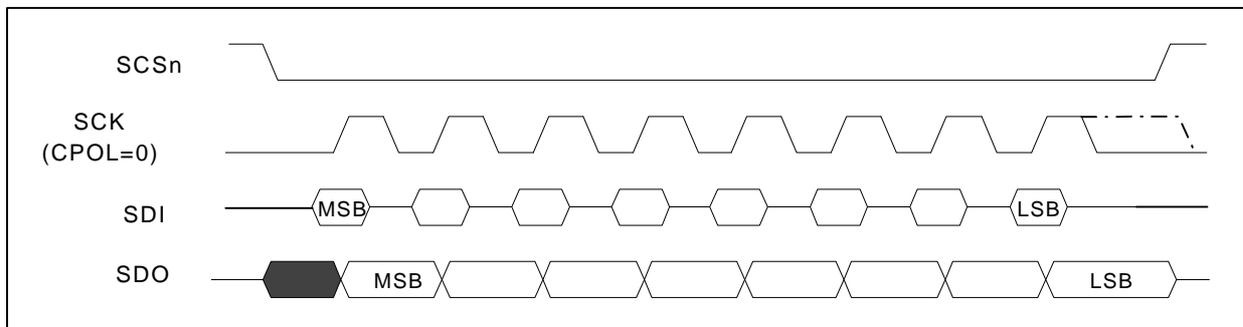


Figure 3 SPI - Physical interface

Communication Protocol

The SPI-interface acts as communication interface between the μ Controller and the registers within the Single Motor H-Bridge Controller. For efficient register access, a protocol has been defined with the following features:

- Purely master-slave protocol with μ Controller as master
- Only one register accessible within one telegram
- Two different frames: One read and one write frame
- Frame is delimited by the status of SCSn (SCSn = frame delimiter)

Application Note

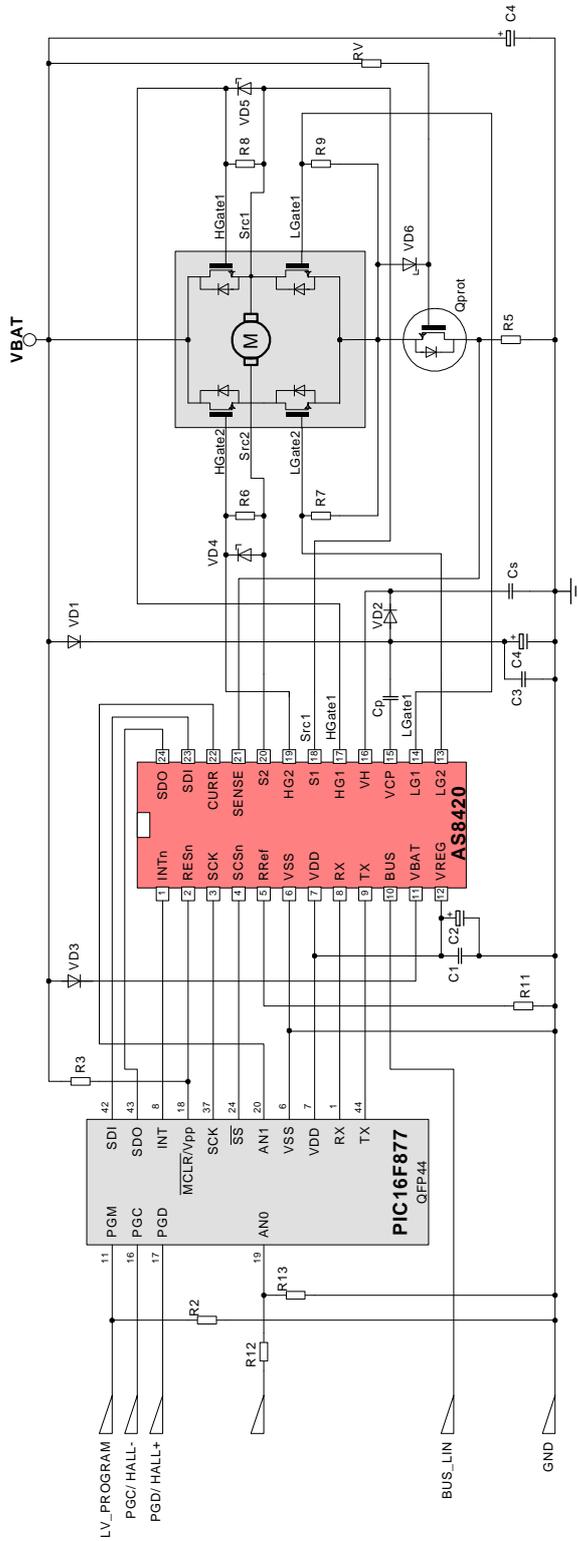


Figure 4 full configured μ Controller driven system

MARKING / PACKAGE - PRODUCTION PARTS

Package type: SOIC24

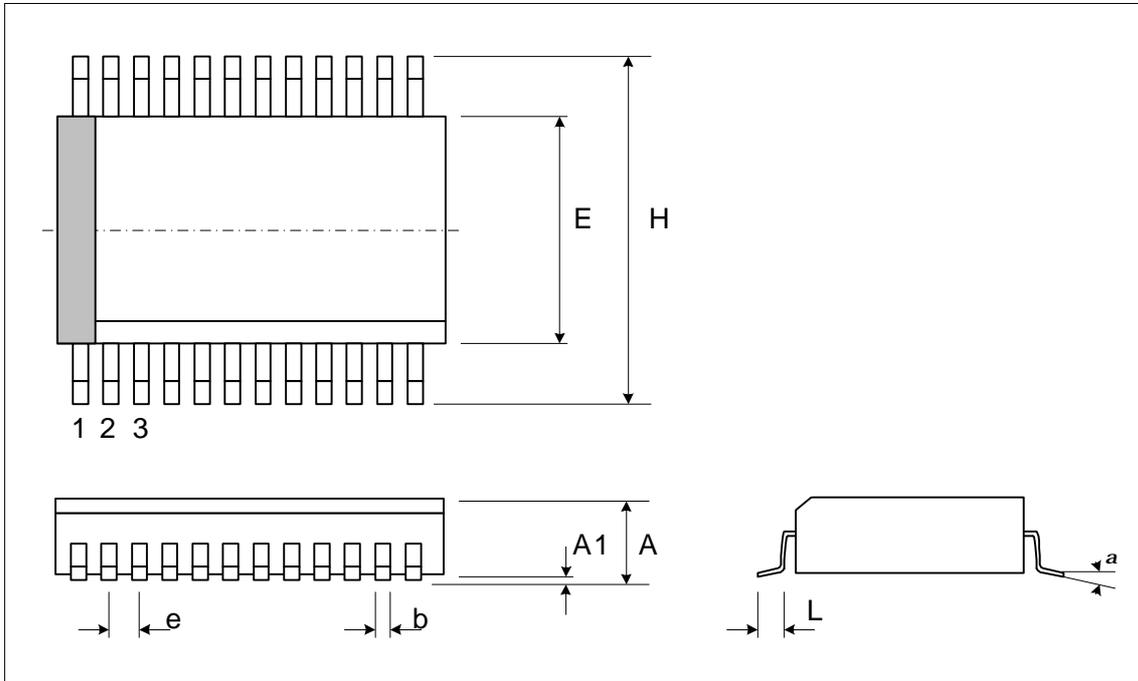


Figure 5 SOIC24 Package

	D	E	H	A	A1	e	b	L	Copl.	a
min	15.20	7.40	10.00	2.35	0.1	1.27	0.33	0.40	0.10	0 °
max	15.60	7.60	10.65	2.65	0.30		0.51	1.27		8 °

Table 10 Package Dimensions

Marking: YYWWIZZ YY year
 WW week
 I plant identifier
 ZZ letters of free choice

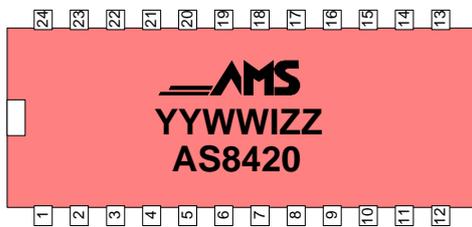


Figure 6 Package Marking

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